

PROTECTION PRODUCTS - RailClamp[®] Description

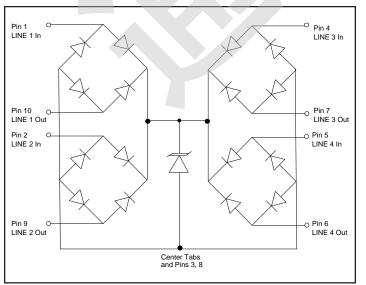
RailClamp[®] TVS diodes are specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (cable discharge events), and EFT (electrical fast transients).

The unique design incorporates surge rated, low capacitance steering diodes and a TVS diode in a single package. The RClamp[®]2574N is designed to replace up to two components for board level GbE protection. Each device is designed to protect two line pairs. This is accomplished by routing traces through the device. When connected in this fashion, the device can withstand a high level of surge current (40A, 8/ 20us) while maintaining a low loading capacitance of less than 5pF. The high surge capability means it can be used in high threat environments in applications such as Gigabit Ethernet, telecommunication lines, and LVDS interfaces.

The RClamp[®]2574N is constructed using Semtech's proprietary EPD process technology. The EPD process provides low stand-off voltages with significant reductions in leakage current and capacitance over silicon-avalanche diode processes. It features a true operating voltage of 2.5 volts for superior protection. The RClamp2574N is in a 10-pin SLP3020N10 pack-

age. It measures $3.0 \times 2.0 \times 0.60$ mm. The leads are finished with lead-free NiPdAu.

Schematic



Features

- Transient protection for high-speed data lines to IEC 61000-4-2 (ESD) ±30kV (air), ±30kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns) IEC 61000-4-5 (Lightning) 40A (8/20µs)
- Array of surge rated diodes with internal TVS Diode
- Small package saves board space
- Protects two line pairs
- Low capacitance for high-speed interfaces
- Low variation in capacitance vs. bias voltage
- Low clamping voltage
- Low operating voltage: 2.5V
- Solid-state silicon-avalanche technology

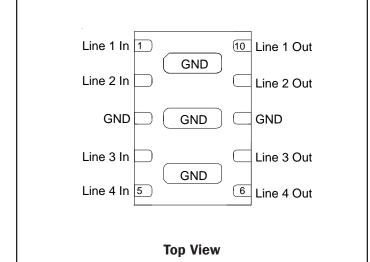
Mechanical Characteristics

- SLP3020N10 10L package
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Nominal Dimensions: 3.0 x 2.0 x 0.60 mm
- Lead Finish: NiPdAu
- Molding compound flammability rating: UL 94V-0
- Marking : Marking code + Date code
- Packaging : Tape and Reel

Applications

- 10/100/1000 Ethernet
- Central Office Equipment
- LVDS Interfaces
- ◆ MagJacks / Integrated Magnetics
- Notebooks / Desktops / Servers

Pin Configuration



Revision 10/20/2010

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PROTECTION PRODUCTS

Absolute Maximum Rating

Rating	Symbol	Value	Units	
Peak Pulse Power (tp = $8/20\mu s$) ¹	P _{pk}	1000	Watts	
Peak Pulse Current (tp = $8/20\mu s$) ¹	I _{pp}	40	А	
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{esd}	+/-30 +/-30	kV	
Operating Temperature	T,	-55 to +85	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units	
Reverse Stand-Off Voltage	V _{RWM}				2.5	V	
Punch-Through Voltage	V _{PT}	Ι _{ΡΤ} = 2μΑ	2.7			V	
Snap-Back Voltage	V _{SB}	I _{sb} = 50mA	2.0			V	
Reverse Leakage Current	I _R	V _{RWM} = 2.5V, T=25°C			0.5	μA	
Clamping Voltage	V _c	$I_{pp} = 1A, t_p = 8/20\mu s$ Any I/O to Ground			4.5	V	
Clamping Voltage ²	V _c	$I_{pp} = 10A$, $t_p = 8/20\mu s$ Any 1 I/O to Ground			7.5	V	
Clamping Voltage ²	V _c	I_{pp} = 25A, t_p = 8/20µs Any I/O to Ground			12	V	
Clamping Voltage ^{1,2}	Vc	I _{pp} = 40A, t _p = 8/20μs Line-to-Line, two I/O pins connected together on each line (Note 1)			20	V	
Junction Capacitance ²	C _j	V _R = 0V, f = 1MHz Any I/O to Ground		3.75	5	pF	
		V _R = OV, f = 1MHz Between I/O pins		1.7		pF	

Notes:

1) Ratings with 2 pins connected together per the recommended configuration (ie pin 1 connected to pin 10, pin 2 connected to pin 9, pin 4 connected to pin 7, and pin 5 connected to pin 6).

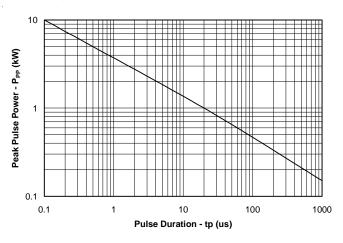
2) Guaranteed by design (not production tested)

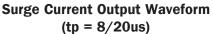


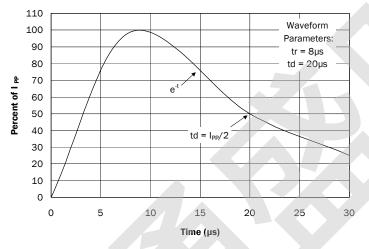
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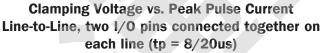
Typical Characteristics

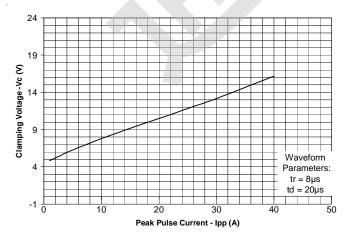
Non-Repetitive Peak Pulse Power vs. Pulse Time

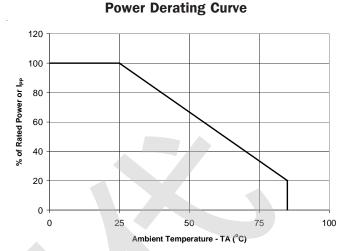




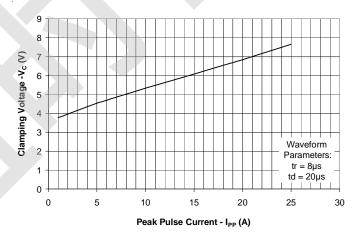




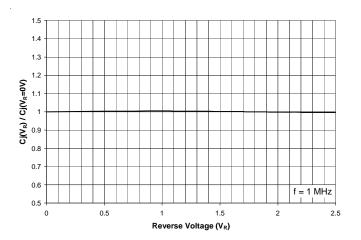




Clamping Voltage vs. Peak Pulse Current Any I/O to GND (tp = 8/20us)



Normalized Capacitance vs. Reverse Voltage



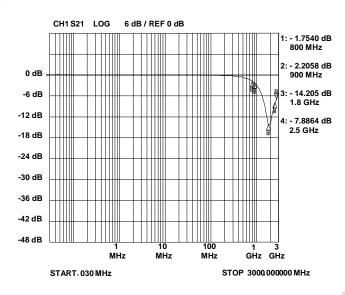
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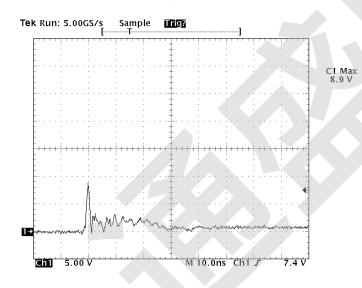
电话:0755-83387360 手机:13826508770(王先生) 邮箱: 3007605919@qq.com 网址:www.sztssd.com 地址:深圳市福田区中航路鼎诚国际南座18楼1814室



Insertion Loss S21 (I/O to Gnd)

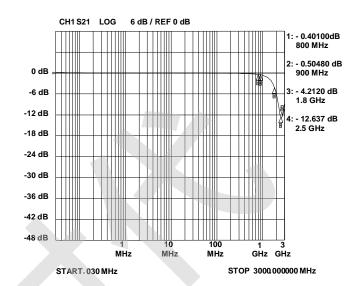


ESD Clamping - I/O to Gnd (8kV Contact per IEC 61000-4-2)

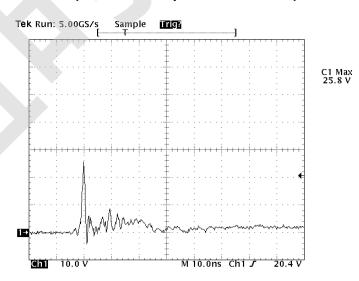


Note: Data is taken with a 10x attenuator

Insertion Loss S21 (I/O to I/O)



ESD Clamping - I/O to Gnd (30kV Contact per IEC 61000-4-2)



RClamp2574N



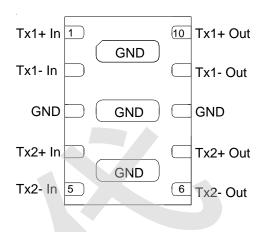
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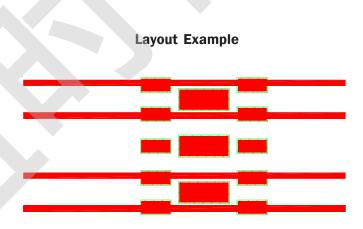
Device Connection Options for Protection of Four High-Speed Data Lines

This device is designed to protect four high-speed data lines (two line pairs). It has been optimized for use on Ethernet interfaces where large magnitude lightning and ESD surges are expected. The RClamp2574N is constructed using Semtech's proprietary EPD process technology. The EPD process provides low stand-off (turn-on) voltages with significant reductions while maintaining good clamping characteristics and high surge capability. They feature a true operating voltage of 2.5 volts. Each I/O pin pair features a low capacitance steering diode bridge that is designed to route harmful surge current into the internal low voltage TVS diode. Each data pair is rated to withstand 1000 Watts of surge power (8/20us impulse waveform). When placed on the PHY side of the magnetics, it can be used to meet the requirements of Telcordia GR-1089, K.20, K.21, and other high energy surge standards.

The RClamp2574N is designed with a flow through pin configuration for easy layout. In a GbE application, TX+ and TX- lines would enter at pins 1, 2, 4, and 5 and exit at pins 10, 9, 7, and 6 respectively. The traces should be unbroken and run under the device as shown. Pins 3 and 8 are electrically connected to the three center ground tabs. In a typical Ethernet application, these pins as well as the tabs should be left floating (i.e. not connected to ground).

Pin Configuration







PROTECTION PRODUCTS

Applications Information

Gigabit Ethernet Protection Solutions

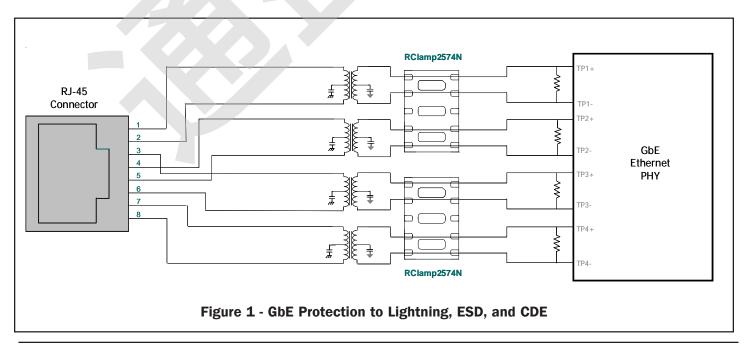
Ethernet systems with connections external to the building are subject to high-level transient threats. This type of equipment may even be required to meet the surge immunity requirements of Telcordia GR-1089. Reliable protection of the Ethernet transceiver requires a device that can absorb the expected transient energy, clamp the incoming surge to a safe level, and yet remain transparent to the system under normal operation. The RClamp2574N has been designed to meet these demanding requirements.

Transient Protection

When designing Ethernet protection, the entire system must be considered. An Ethernet port includes interface magnetics in the form of transformers and common mode chokes. Transformers and chokes can be discrete components, but integrated solutions that include the RJ-45 connector, resistors, capacitors, and protection are also available. In either case, the transformer will provide a high level of common mode isolation to external voltages, but no protection for metallic (line-to-line) surges. During a metallic transient event, current will flow into one line, through the transformer and back to the source. As the current flows, it charges the windings of the transformer on the line side. Once the surge is removed, the windings on the line side will stop charging and will transfer its stored energy to the IC side where the PHY IC is located. The magnitude and

duration of the surge is attenuated by the inductance of the magnetics. The amount of attenuation will vary by vendor and configuration of the magnetics. It is this transferred energy that must be clamped by the protection circuitry.

A typical protection scheme which utilizes the RClamp2574N is shown in Figure 1. One device is placed across two line pairs and is located on the PHY side of the transformer as close to the magnetics as possible. This is done to minimize parasitic inductance and improve clamping performance. In this design, the isolation voltage of the transformer is relied upon to suppress common mode lightning surges. High voltage capacitors and resistors are commonly utilized from the center tap to ground to aid in transient protection. Metallic surges will be transferred in some form to the PHY side and clamped by the RClamp2574N. The RClamp2574N will turn on when the voltage across it exceeds the punch-through voltage of the device. Low voltage turn on is important since many PHY chips have integrated ESD protection structures. These structures are for protection of the device during manufacture and are not designed to handle large amounts of energy. Should they turn on before the external protection, they can be damaged resulting in failure of the PHY chip.



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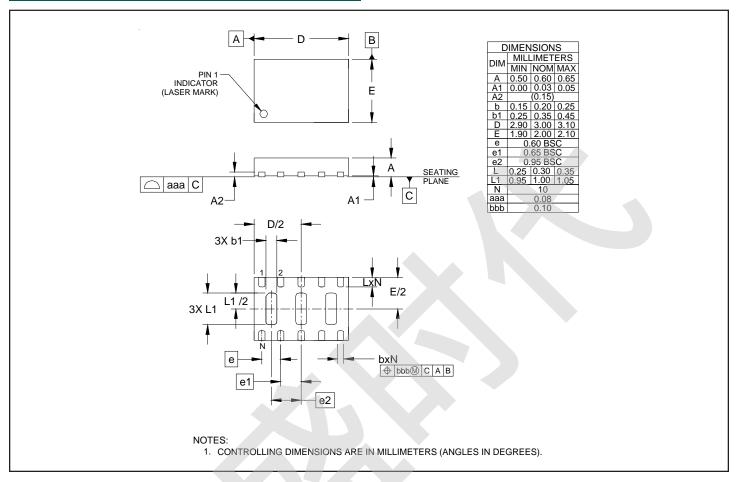
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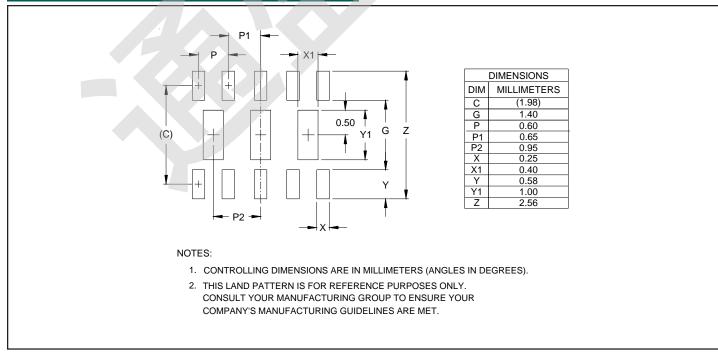
RClamp2574N

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Outline Drawing - SLP3020N10



Land Pattern - SLP3020N10

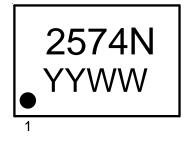




RClamp2574N

PROTECTION PRODUCTS

Marking



Ordering Information

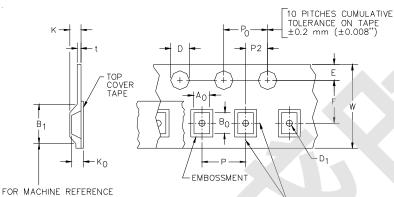
Part Number	Working Voltage	Qty per Reel	Reel Size	
RClamp2574N.TCT	2.5 Volts	3,000	7 Inch	

RailClamp and RClamp are trademarks of Semtech Corporation

YYWW = Date Code

ONLY INCLUDING DRAFT AND RADII CONCENTRIC AROUND BO

Tape and Reel Specification



USER DIRECTION OF FEED

Pin 1 Location (Towards Sprocket Holes)

User Direction of feed

2574N YYWW 2574N YYWW

2574N YYWW

Device Orientation in Tape

AO	во	ко
2.24 +/-0.05 mm	3.23 +/-0.05 mm	0.93 +/-0.05 mm

Tape Width	B, (Max)	D	D1	E	F	K (MAX)	Ρ	PO	P2	T(MAX)	W
8 mm	4.2 mm	1.5 + 0.1 mm - 0.0 mm)	0.5 mm ±0.05	1.750±.10 mm	3.5±0.05 mm	2.4 mm	4.0±0.1 mm	4.0±0.1 mm	2.0±0.05 mm	0.4 mm	8.0 mm + 0.3 mm - 0.1 mm

CENTER LINES OF CAVITY

Contact Information

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